

Polytec EC 244

Properties

Polytec EC 244 is a standard two-component, solvent-free, electrically conductive epoxy adhesive with a short pot life and curing at room temperatures.

Polytec EC 244 is suggested for short time processing and low temperature curing applications.

Polytec EC 244 can be also cured at 50°C in 1h.

The material can be applied by dispensing or manually.



Processing

- For two-component products the components A and B should be mixed carefully within the specified mixing ratio.
- For filled products both components should be homogenized carefully prior mixing, in order to prevent a possible settling of the filler.
- Processing should be carried out rapidly after mixing the components; as an indication the pot life can be used.
- Surfaces should be clean, thus free of dirt, grease, oil, dust or process chemicals.
- One-component products can be applied directly and are not subject to a pot life (except pre-mixed/frozen products).
- Please take notice of respective minimum curing temperature and time.
- For Safety information please refer to the respective Material Safety Data Sheet.

Polytec EC 244

Electrically Conductive Adhesive

Technical Data

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Properties in uncured state	Method	Unit	Technical Data
Chemical basis	-	-	Epoxy
No. of components	-	-	2
Mixing ratio (weight)	-	-	100:10
Mixing ratio (volume)	-	-	-
Pot life at 23°C	TM 702	min	15
Storage Stability at 23°C	TM 701	months	12
Consistency	TM 101	-	Creamy Paste
Density Mix	TM 201.2	g/cm ³	2.96
Density A-Part	TM 201.2	g/cm ³	-
Density B-Part	TM 201.2	g/cm ³	-
Type of filler	-	-	Silver
Max. particle size	-	µm	<40
Viscosity Mix 84 s ⁻¹ at 23°C	TM 202.1	mPa·s	9 000
Viscosity A-Part 10 s ⁻¹ at 23°C	TM 202.4	mPa·s	180 000
Viscosity B-Part 84 s ⁻¹ at 23°C	TM 202.1	mPa·s	600

Properties in cured* state	Method	Unit	Technical Data
Color	TM 101	-	Silver
Hardness (Shore D)	DIN EN ISO 868	-	70
Temperature resistance continuous	TM 302	°C	-40/ +150
Temperature resistance short term	TM 302	°C	+180
Degradation Temperature	TM 302	°C	-
Glass Transition Temperature (T _g)	TM 501	°C	-
Coefficient of thermal expansion (<T _g)	ISO 11359-2	ppm	-
Coefficient of thermal expansion (>T _g)	ISO 11359-2	ppm	-
Thermal conductivity		W/m·K	-
Specific volume resistivity	DIN EN ISO 3915	Ω·cm	<5· 10 ⁻³
Electrical conductivity	DIN EN ISO 3915	S/m	-
Elasticity modulus	TM 605	N/mm ²	4 800
Tensile Strength	TM 605	N/mm ²	27
Lap shear strength (Al/Al)	TM 604	N/mm ²	7.8
Elongation at break	TM 605	%	0.7
Water absorption 24 h, 23°C	TM 301	%	-

*The above data has been determined with samples cured at 50 °C. Please notice, by varying the curing temperature these properties can be influenced to some extend.

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Curing*	Method	Unit	Technical Data
Minimum curing temperature		°C	23
Curing time at 23°C		h	24
Curing time at 50°C		min	60
Curing time at 80°C		min	15

*Curing temperatures refer to the temperature in the respective bond line. When choosing the respective curing conditions, the time needed to heat the substrate has to be considered. Depending on the type of heat source (convection oven, hot stamp, heating plate) the heat input may vary.

Standard pack sizes:

30 g, 250 g, 500 g

Customized Packaging

Please note:

The above listed information are typical data based on tests and are believed to be accurate. Polytec PT makes no warranties (expressed or implied) as to their accuracy. The above listed data do not constitute specifications. The processing (in particular the cure conditions) of the material, the process control and the variety of different applications at various customers are not under Polytec PT's control. Therefore Polytec PT will not be liable for concrete results in any specific application or in any connection with the use of this product. In particular the cure conditions do have a major effect on the properties of the cured material. Therefore it is highly recommended to keep the cure schedule – once established - under tight control. With the release of this data sheet all former data sheets will be null and void.

Subject to alteration.

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